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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

ATTY. DOCKET NO.:
57761.000108

INVENTOR'S NAME:
Allen M. Ritter, et al.

FILING DATE:
May 31, 2002

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57761.000108

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LIST OF MATERIALS CITED BY APPLICANT

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U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		Ι.	DOC	UME	NTI	NUM	BER		DATE .	NAME	CLASS	SUB CLASS	FILING DATE
154	Ä	6 -	0	1	8	4	5	9	01/25/00	Carlson, et al.			
	В	6	1	3	1	6	4	4	10/17/00	Kohara, et al.			
	С	6	T	3	1	6	5	0	10/17/00	North et al.			
	D	5	9	8	7	8	9	3	11/23/99	Schulz-Harder, et al.			
	E	6	0	1	4	3	ī	2 .	01/11/00	Schulz-Harder et al.			
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ale	G	5	2	0.	5	. 3	5	3	04/27/93	Willemsen, et al.			
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FOREIGN PATENT DOCUMENTS

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OTHER MATERIALS (Including Author, Title, Date, Pertinent Pages, Etc.)

"Fluid-Cooled DBC Substrates," by J. Schulz-Harder, K. Exel, and A. Meyer

"Direct Bond Copper Substrates," from Thermalloy

XAMINER / DATE CONSIDERED ...

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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